Piyush Sao, Ramakrishnan Kannan^{*} Oak Ridge National Laboratory Oak Ridge, TN {saopk,kannanr}@ornl.gov Xiaoye Sherry Li Lawrence Berkeley National Laboratory Berkeley, CA xsli@lbl.gov Richard Vuduc Georgia Institute of technology Atlanta, GA richie@gatech.edu

ABSTRACT

We present a novel distributed memory algorithm to improve the strong scalability of the solution of a sparse triangular system. This operation appears in the solve phase of direct methods for solving general sparse linear systems, Ax = b. Our 3D sparse triangular solver employs several techniques, including a 3D MPI process grid, elimination tree parallelism, and data replication, all of which reduce the per-process communication when combined. We present analytical models to understand the communication cost of our algorithm and show that our 3D sparse triangular solver can reduce the per-process communication volume asymptotically by a factor of $O\left(n^{1/4}\right)$ and $O\left(n^{1/6}\right)$ for problems arising from the finite element discretizations of 2D "planar" and 3D "non-planar" PDEs, respectively. We implement our algorithm for use in SuperLU_DIST3D, using a hybrid MPI+OpenMP programming model. Our 3D triangular solve algorithm, when run on 12k cores of Cray XC30, outperforms the current state-of-the-art 2D algorithm by 7.2x for planar and 2.7x for the non-planar sparse matrices, respectively.

KEYWORDS

sparse matrix computations, distributed-memory parallelism, communication-avoiding algorithms

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1 INTRODUCTION

This paper presents a new algorithm for solving a sparse triangular system of linear equations, Tx = b, where T is either an upper- or lower-triangular sparse matrix. A sparse triangular solver (SPTRs) is an important sub-step during LU and Cholesky factorization, which

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ACM ISBN 978-1-4503-6079-1/19/06...\$15.00 https://doi.org/10.1145/3330345.3330357 are direct methods for solving general linear systems. SPTRs also appears in preconditioners based on incomplete factorization, which commonly appear in Krylov subspace-based iterative methods.

In the context of distributed memory sparse direct methods for solving Ax = b, where A is any general matrix, consider the example of sparse LU factorization. It first decomposes A into the product A = LU, where L and U are lower- and upper-triangular matrices, respectively. Then, one may solve for x by a pair of SpTRs operations, Ly = b and Ux = y. In this setting, the factorization step (determining L and U) usually dominates the pair of SpTRs operations. However, a common use-case for sparse direct solvers is using *many* right-hand sides for a fixed matrix (pattern). This scenario occurs in time-stepping numerical ODE solvers, where bchanges at each time step. Similarly, in the case of a sparse iterative solver, we might factor the system once upfront and then invoke SpTRs with a new right-hand side during each iteration. Thus, the scalability of SpTRs can also become a bottleneck.

In our previous work, we developed a communication-avoiding algorithm for LU factorization [21]. The idea underlying this SU-PERLU_DIST3D method is to organize the MPI processes logically into a three-dimensional grid, rather than a traditional 2D one, and then exploit the structure of the *elimination-tree*—an abstraction that captures the data dependencies in sparse LU factorization—to replicate data judiciously. This combination of techniques provably reduces communication asymptotically in the problem size in common cases. In this work, we leverage the 3D sparse LU data structure of SUPERLU_DIST3D to develop a communicationavoiding SpTRs, which yields asymptotic reductions in the latency and communication-volume costs of a conventional SpTRs.

Briefly, our new 3D SpTRs works as follows. Consider the 3D process grid as a collection of 2D MPI process grids. The prior technique of SUPERLU_DIST3D mapped independent subtrees of the elimination-tree to each 2D process grid and replicated the common ancestors. Our 3D triangular solver exploits this same 3D organization. It first solves independent subtrees on different 2D process grids, and then performs a reduction before solving the subproblem in the common ancestor tree on a single 2D grid.

To analyze the communication and latency costs of our new method, we consider prototypical matrices arising from the discretization of "planar" and "non-planar" PDEs. We would like to clarify that, a planar problem is one where the physical geometry of the input domain, when discretized, is flat or nearly so; we use the term planar instead of 2D to distinguish the problem geometry from that of the logical MPI process grid. Our analysis shows that the 3D SPTRs can reduce the communication and latency costs by a factor of $O\left(\frac{1}{\sqrt{p_z}}\right)$, over a purely 2D algorithm, where p_z is the number of 2D process grids. This advantage comes at the cost of a

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small amount of additional memory, which is needed to replicate the right-hand side.

We present empirical scalability results for our 3D SPTRs on up to 24k cores of a Cray XC30 machine. For a single right-hand side, our 3D SPTRs achieves 4.6× and 1.8× speedup over the baseline 2D algorithm for planar and non-planar matrices, respectively. For multiple right-hand sides, our 3D SPTRs achieves 7.2× and 2.7× speed-up over the baseline 2D algorithm for planar and non-planar matrices, respectively. Even though, we present the discussions in the context of triangular matrices in direct methods, without loss of generality, it can be extended to general cases as well and SPTRs can actually improve the direct solver itself.

2 BACKGROUND

In this section, we review relevant background sufficient to understand the new algorithm (Section 3) and its analysis Section 4. We first give an overview of sparse triangular systems arising from sparse direct solver and the baseline parallel triangular solver algorithm. Then we briefly discuss the 3D sparse LU data structure introduced in [21], which is also used by the new algorithm.

Terminology. In general, triangular solver for a single right-hand side known as xTrsv and multiple right-hand sides known as xTrsm is optimized differently on the single node case. In this paper, we do not require to distinguish between the two cases as we are concerned with distributed memory scalability aspect of it, and use the term SpTrs to denote the two cases of the parallel sparse triangular solver. SpTrS2D is used to refer the baseline sparse triangular solver algorithm that uses 2D process grid, and we call the new 3D sparse triangular solve algorithm SpTrS3D.

2.1 Sparse Direct Solver

A sparse direct solver computes the solution of Ax = b in the following three steps.

- **Pre-Processing:** The matrix *A* is permuted to improve the numerical stability and to reduce the *fill-ins* in *L* and *U* factors. This step also involves the *symbolic-factorization* to compute the fill-in structure and sparse meta-data for the next step numerical factorization.
- Numerical Factorization: In this step, we compute the unit lower triangular *L* and the upper triangular *U* factors so that *A* = *LU*.
- **Solve Step:** We solve the lower triangular system Ly = b for *y* followed by solving the upper triangular system Ux = y to find the final solution *x*.

SPTRS is used in the the solve-step of the direct solver. In general, numerical factorization is the costlist step in the direct solver and data structure is designed to optimize it. Hence SPTRS is designed to use the data structure which is optimized for the numerical factorization step. Designing 3D data structure to improve scalability of numerical factorization was the subject of our previous work[21]. In this paper, we design and analyze sparse triangular solvers on the 3D data structure.

2.2 Triangular Systems

Table 1: List of symbols used

Symbol type	Symbol	Description	
	Р	#MPI processes	
	P_x, P_y, P_z	Process grid dimensions	
	Pxy	$P_x \times P_y$ # processes in xy plane	
Process	p_x, p_y, p_z	Process coordinates	
1100033	$P_r(k)$	$(k \mod P_x)$ -th process row	
	$P_c(k)$	$(k \mod P_y)$ -th process column	
	P_{kk}	Process that owns A_{kk} block $(P_{kk} = P_r(k) \cap P_c(k))$	
	Ε	Elimination tree of <i>A</i>	
	S	Top level separator of E	
Graphs	C_1, C_2	Children etrees of E	
	Desc(k)	Descendants of node k in E	
	Anc(k)	Ancestors of node k in E	
	n	Dimension of the matrix A	
	1	$\log_2 P_z$	
	W	Communication cost	
Misc.	V	Per-process communication volume	
	α	Cost of initiating a data transfer	
	β	Cost of transferring a unit data	
	Y	Number of right hand sides	

Algorithm 1 Forward substitution algorithm for solving lower triangular system of equation Ly = b

1:	function	LSOLVE (L,b) :
		(=)

2:	$n \leftarrow \dim(L)$
3:	for $i = \{1, 2, n\}$ do:
	$b_i - \sum_{i=1}^{i-1} l_{ii} u_i$

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				l

5: Return y



Figure 1: A 3 \times 3 block sparse "arrowhead" matrix, its L and U factors and its block-elimination tree.

2.2.1 Dense triangular solver. A triangular system can be directly solved due to its structure. Consider, a lower triangular matrix Lx = b for solving x_1, \dots, x_n , first one computes $x_1 = b_1/l_{11}$, substitute the computed x_1 into the second equation and solve for x_2 . This process of solve-and-substitute is carried out sequentially until all x_i 's, $\forall i \in [1, n]$ are found, as shown in Algorithm 1. When the matrix is upper triangular, the process of solve-and-substitute is carried out in reverse order, i.e., x_n is solved first and x_1 in the last, where *n* denotes the dimension of the system. The process of solving lower and upper triangular systems are also called forward-substitution and backward-substitution, respectively.

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2.2.2 Triangular systems in sparse direct solvers. Triangular system arising from sparse direct solvers have a recursive block-arrowhead structure. For instance, in Fig. 1 we show a 3×3 block sparse matrix *A*, and its final *L* and *U* factors.

Consider a triangular system Ly = b, where L is the 3×3 lower triangular matrix shown in Fig. 1. Note that block L_{21} is zero, therefore $L_{11}y_1 = b_1$ and $L_{22}y_2 = b_2$ can be solved concurrently. Following that, $L_{33}y_3 = b_3 - L_{31}y_1 - L_{32}y_2$ can be solved for y_3 . This dependency in solution of block 3×3 lower triangular system is shown as a directed-acyclic graph (DAG) in Fig. 1. The dependency in L solve is the same as dependency in elimination of nodes in the numerical factorization step; and is referred as *elimination* tree or etree.

2.3 Dependency in Sparse Triangular Solver

The block sparse matrix shown in Fig. 1 comes from so-called nested-dissection (ND) ordering of the input matrix[6]. Such an ordering is primarily used for reducing fill-ins in L and U matrices. It also exposes parallelism in sparse LU factorization and triangular solve.

Briefly ND ordering works as follows. Any sparse matrix A has a associated graph G, which has same number of vertex as the dimension of A, and for any non-zero entry a_{ij} in A, there is an edge in G from vertex v_i to v_j . For instance, in Fig. 2a, we show a 25×25 sparse matrix that arises from finite difference discretization of a 5 \times 5 grid is shown in Fig. 2b. The ND ordering partitions in the graph G into three disjoint vertex set $\{C_1, S, C_2\}$ such there are no edges from any vertex in C_1 to any vertex in C_2 . The vertex set S is called the *separator*. Using this partition, we reorder the matrix A so that the vertices in S are numbered last. In Fig. 2b, we highlight the separator and in Fig. 2c, we show the reordered matrix. The Fig. 1a shows a simplified block representation of the reordered matrix Fig. 2c where A_{11} , A_{22} , and A_{33} correspond to C_1 , C_2 , and S respectively, with remaining submatrices representing the edges that connect these partitions. The partition C_1 and C_2 are recursively dissected to get more disjoint subgraphs till each subgraph is sufficiently small. Graph partitioning tools such as METIS[15] or PT-SCOTCH [18] can be used for calculating such a partition.

As shown in Fig. 3, ND ordering leads to a multi-level dependency tree, also known as elimination tree or etree. Etree describes the order of elimination in the numerical factorization process. LSOLVE has the same dependency as numerical factorization, so the etree also describes the dependency in LSOLVE.

When the input matrix A is symmetric, USOLVE follows the reverse order that of LSOLVE, i.e., LSOLVE traverses the etree in a post-order or bottom-up order, whereas USOLVE traverses the etree in top-down order. When the matrix A is asymmetric, USOLVE may traverse a slightly different tree than etree in top-down order. For simplicity, in subsequent discussion, we assume that in the unsymmetrical case the etree is obtained by applying ND on the symmetric matrix $A + A^T$. Hence the dependency tree for USOLVE is reverse that of LSOLVE.

2.4 Parallel Sparse Triangular Solve

2.4.1 SUPERLU_DIST Data Structure. Our algorithm is built on top of SUPERLU_DIST. SUPERLU_DIST is an open-source sparsedirect solver library for general sparse matrices that uses rightlooking scheduling and static pivoting. The baseline SUPERLU_DIST uses a two-dimensional logical process arrangement. In the two dimensional process-grid, it distributes the input matrix A into 2D block-cyclic fashion. After the factorization, A matrix is overwritten by L and U factors. Hence, L and U matrix are also distributed in block cyclic fashion. The right hand side b vector is distributed among the diagonal processes, so that b_k is owned by P_{kk} . Table 1 presents the brief description of the notations used in this section.

2.4.2 *Distributed LSOLVE*. The LSOLVE performs following operation to calculate k-th segment of solution y_k :

$$y_k \leftarrow L_{kk}^{-1} \left(b_k - \sum_{j \in Desc(k)} L_{kj} y_j \right).$$
⁽¹⁾

This operation is performed in 2D process grid using following operations. Any process $P_{kj} \in P_r(k)$, keeps a vector s_k to accumulate the local update $-L_{kj}y_j$.

- Local Solve: P_{jj} solves $L_{jj}y_j = b_j$ for y_j .
- Broadcast: P_{jj} broadcasts the computed y_j across its process column P_c(j)
- Local Update: Any process $P_{kj} \in P_c(j)$ that owns a nonempty block L_{jk} receives y_j , and performs the local update:

$$s_k \leftarrow s_k - L_{kj} y_j$$

Reduction: When all process in P_r(k) have finished all the updates on s_k, the vector s_k is reduced across P_r(k), to accumulate all the updates to P_{kk}

$$s_k \leftarrow \sum_{i \in P_r(k)} s_k^i,$$

where s_k^i is the s_k from the *i*-th process in $P_r(k)$. P_{kk} updates $b_k \leftarrow b_k - s_k$ so that

$$b_k \leftarrow b_k - \sum_{j \in Desc(k)} L_{kj} y_j,$$

and P_{kk} performs k-th local-solve.

In LSOLVE, y_k are computed in bottom-up order of etree to maximize available parallelism.

2.4.3 Limitations of 2D LSOLVE. In the distributed LSOLVE algorithm, local-update is the main computation step, whereas broadcast and reduction are two main communication substeps. Assuming the computation is load balanced then local-update can exploit all the available *P* processors concurrently. However, each process participates in $O\left(\frac{n}{\sqrt{P}}\right)$ broadcasts and $O\left(\frac{n}{\sqrt{P}}\right)$ reductions. Therefore, broadcast and reduction step only scales as $1/\sqrt{P}$. Hence the communication in LSOLVE doesn't scale as well as the computation.

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(a) A 25×25 sparse matrix



(b) The associated graph and separator



(c) Reordered sparse matrix using ND or dering

Figure 2: A sparse matrix (Fig. 2a), its associated graph (Fig. 2b), and a separator (highlighted in yellow); and the re-ordered matrix (Fig. 2c) using nested dissection (ND) ordering. The ND orders the variables so that the variables corresponding to the separator are numbered last.



Figure 3: An 18 × 18 sparse matrix and its elimination tree obtained by ND ordering (Section 2.3). Here light yellow squares represent zero entries, blue entries represent non-zero entries in *A*, and red squares represent non-zero entries due to *fill-in* during the factorization.

2.5 3D Sparse LU factorization

In our previous work, we presented a communication-avoiding extension of SUPERLU_DIST's numerical factorization step, that uses three dimensional data distribution instead of two. The new algorithm SpTrS3D uses this 3D distribution.

2.5.1 3D Data Distribution. The 3D sparse LU algorithm uses elimination tree to guide the data distribution in 3D process grid. The 3D process grid can be considered as P_z 2D grids of size P_{xy} . In the 3D algorithm, the etree is partitioned into independent subtrees, and each independent subtree, called leaf subtree, is assigned to a 2D grid. Each 2D grid also keeps a copy of the ancestors-subtree of the leaf subtree to perform so-called *Schur-complement* updates. For instance, in Fig. 4a, we show a two-level partition of the etree, and in Fig. 4b we show how this partition is mapped to four 2D process grids. The root of the etree node-0, is replicated on grid-0 and 1; and grid-2 and 3 respectively. In the last level, node 3 to 6 corresponds to an entire subtree of the etree, and are assigned to only one one of the 2D grid.





(b) Mapping of matrix blocks to 3D process grid

Figure 4: Three-dimensional data distribution in SUPERLU_DIST3D [21]. In Fig. 4a we show the global elimination tree. Nodes 0 to 2 are *ancestor-subtrees* and nodes 3 to 6 are leaf subtrees. In Fig. 4b, we show how the ancestor and leaf subtrees are mapped to four 2D process grids.

2.5.2 3D Factorization Algorithm. In the 3D factorization algorithm, each grid factors its leaf-subtree and performs update on its copy of the ancestor subtrees. Before factoring an ancestor subtree, updates on all the copies of subtree is reduced to one process grid and then factored in 2D fashion.

At the end of the factorization, all the LU factors are gathered into a 2D grid to perform the solve step. Doing so has the following drawbacks to be addressed in this paper:

• Before one can perform the solve step, all the *L* and *U* factors need to be gathered in a single 2D grid, which requires extra communication and synchronization overhead.

- The solve step can only use *P_{xy}* processors, and the remaining processes are idle.
- As we see in Section 4, 2D solve algorithm has higher communication costs, thus shows poor scalability.

3 3D TRIANGULAR SOLVER

In this section, we describe the 3D triangular solve algorithm for sparse matrices. First, we describe the algorithm for 3×3 block sparse case on two 2D process grids ($P_z = 2$), and then we generalize it for $P_z = 2^l$.

3.1 3×3 block sparse case

Consider the 3×3 block sparse *L* and *U* matrix distributed over two 2D process grids as shown in Fig. 1. Sparse block matrices L_{11} , L_{31} and U_{11} , U_{13} reside on grid-0; and L_{22} , L_{32} and U_{22} , U_{23} reside on grid-1. The factored block L_{33} and U_{33} reside only on grid-0. The right-hand side b_1 and b_2 reside on grid-0 and grid-1, respectively, whereas b_3 is replicated on both the process grids and initialized with zeros on grid-1. Fig. 5, shows the timeline of SPTRS3D involving the *L* and USOLVE substeps.

3.1.1 LSOLVE. In the LSOLVE, both grid-0 and grid-1 solves $L_{11}y_1 = b_1$ and $L_{22}y_2 = b_2$ in parallel, and update corresponding b_3 blocks as

$$b_3^0 = b_3^0 - L_{31}y_1$$

on grid-0, and

$$b_3^1 = -L_{32}y_2$$

on grid-1. After the update, grid-1 sends the b_3^1 to grid-0, which accumulates the updates on b_3 from both grids as follows:

$$b_3^0 = b_3^0 + b_3^1 = b_3^0 - L_{31}y_1 - L_{32}y_2$$

Thus, updated b_3^0 contains updates from both process grids and then, grid-0 solves $L_{33}y_3 = b_3$ for the final y_3 .

3.1.2 USOLVE. The USOLVE can start after grid-0 has computed y_3 . First, the grid-0 solves $U_{33}x_3 = y_3$ for x_3 and sends the x_3 to grid-1. Now using x_3 both grid-0 and grid-1 can update the $y_1 = y_1 - U_{13}x_3$ and $y_2 = y_2 - U_{23}x_3$ respectively. And lastly, grid-0 and grid-1 solve $U_{11}x_1 = y_1$ and $U_{22}x_2 = y_2$ for x_1 and x_2 respectively. So at the end of *L* and *U* solve, the final solution x_1 and x_2 reside in grid-0 and grid-1, and x_3 is replicated in both process grids. Note that communication pattern in USOLVE is reverse of LSOLVE.

3.2 General Case

In subsequent discussion, we focus on LSOLVE since, qualitatively *U*- and LSOLVEs have same structure, albeit in a reverse order.

The 3D sparse LU factorization algorithm in [21], can use $P_z = 2^l$ 2D grids. The triangular solve can be extended for $P_z = 2^l$ in similar fashion as the factorization. In the LSOLVE, each two grid performs the LSOLVE for its leaf-subtree and accumulates update on b_k 's, for each supernode k in its ancestor subtrees. Before performing LSOLVE for ancestor subtree, updates on b_k from different subtrees are reduced to a 2D grid, and the 2D performs the LSOLVE in the 2D fashion.



Figure 5: Timeline (from left to right) of SPTRS3D for $P_z = 2^l$, l = 2 twodimensional process grids. Here each node with label Lk or Uk denotes a 2D triangular solve, $L_{kk}y_k = b_k$ or $U_{kk}x_k = y_k$. A red arrow denotes communication and direction between two process grids.

Table 2: Asymptotic communication cost and volume for SP-TRS2D and SPTRS3D, on planar (2D PDE) and non-planar (3D-PDE) input problems

Problem type	Communication Param	SpTrS2D	SpTrS3D
	Cost (W)	$O\left(\frac{n}{\sqrt{P}} + \sqrt{n}\right)$	$O\left(\frac{n}{\sqrt{P_z P}} + \sqrt{n}\right)$
Planar	Average Volume (V^{avg})	$O\left(\frac{n}{\sqrt{P}}\right)$	$O\left(\frac{n}{\sqrt{P_Z P}}\right)$
(2D PDE)	Max Volume (V ^{max})	$O\left(rac{n}{\sqrt{P}} ight)$	$O\left(\frac{n}{\sqrt{P_{Z}P}} + \frac{\sqrt{nP_{Z}}}{\sqrt{P}}\right)$
	Cost (W)	$O\left(\frac{n}{\sqrt{P}}+n^{2/3}\right)$	$O\left(\frac{n}{\sqrt{P_z P}} + n^{2/3}\right)$
Non-Planar	Average Volume (V^{avg})	$O\left(\frac{n}{\sqrt{P}}\right)$	$O\left(\frac{n}{\sqrt{P_Z P}}\right)$
(3D PDE)	Max Volume (V ^{max})	$O\left(\frac{n}{\sqrt{P}}\right)$	$O\left(\frac{n}{\sqrt{P_z P}} + n^{2/3} \frac{\sqrt{P_z}}{\sqrt{P}}\right)$

For instance, in Fig. 4, the etree is partitioned for $P_z = 2^2$ 2D grids numbered 0 to 3. In the first step, each of the 2D grids performs LSOLVE on the leaf subtrees (node-3 to 6), and performs the updates on respective ancestor subtrees. In the second step, grids 0 and 1 reduce the update on node-1 to grid-0, and grid-0 performs the LSOLVE for node-1; and grids 2 and 3 reduce the update on node-2 to grid-2, and grid-2 performs the LSOLVE for node-2; and both grids 0 and 2 perform the updates on node-0, the root of the tree. In the final step, updates on node-0 from all the grids are reduced to grid-0 and grid-0 performs the LSOLVE in 2D fashion.

The USOLVE starts right after grid-0 has finished LSOLVE for node-0, and then grid-0 performs USOLVE for node-0 and broadcasts it to all the grids, so each process can perform the local-update. In the second step, grid-0 and grid-2 performs the USOLVE for node-1 and 2, respectively; followed by broadcasting it to grid-1 and 3. Finally, each grid performs the USOLVE for their respective leaf-subtree.

We give the pseudocode of 3D LSOLVE in Algorithm 2. We show the timeline for SPTRS3D in Fig. 5 when there are $P_z = 4$ 2D grids.

Require: Factored L and U matrices, b: right hand side; Process coordinates $\{p_x, p_y, p_z\}$; E_f : grid-local etree; $p_z = 2^l$ for some integer l

	LSOLVE : $y \leftarrow L^{-1}b$	
1:	for lvl in $l : 0$ do :	▶ Bottom-up traversal of E_f
2:	if $p_z = k 2^{l-lvl}$, $k \in \mathbb{Z}$ then:	5
3:	$\sigma \leftarrow E_f[\text{lvl}]$	$\triangleright \sigma$ is the index of subtree
4:	$y_{\sigma} \leftarrow \text{lsolve2D}(L_{\sigma}, b_{\sigma})$	
5:	$b_i \leftarrow b_i - \sum_{i \in Anc(\sigma)} L_i y_\sigma$	⊳ Local-update
6:	if $lvl > 0$ then:	
7:	if $k \mod 2 \equiv 0$ then:	\triangleright Note $p_z = k2^{l-lvl}$
8:	$dest = p_z$	
9:	$\operatorname{src} = p_z + 2^{l - \operatorname{lvl}}$	
10:	else:	
11:	$\operatorname{src} = p_z$	
12:	$dest = p_z - 2^{l - lvl}$	
13:	for l_a in $lvl - 1 : 0$ do :	
14:	for $s \in E_f[l_a]$ do:	
15:	if $p_z = \operatorname{src} \operatorname{then}$:	
16:	Send $b_s^{\rm src}$ to dest	
17:	else:	
18:	Receive $b_s^{\rm src}$ from src	
19:	$b_s^{\text{dest}} = b_s^{\text{dest}} + b_s^{\text{src}}$	
	return y	

4 COMMUNICATION ANALYSIS

We analyze the communication costs and volume of the SpTrS3D for triangular matrices that occur in solving the PDEs with two and three-dimensional geometries. We differentiate between the following three communication metrics:

- *Communication Cost W*: It denotes the number of words sent along the critical path of the computation.
- Average per-process communication volume V^{avg}: It denotes the average data sent among all the processes.
- *Maximum per-process communication volume* V^{max}:It denotes the maximum number of data sent by any process.

The difference between communication cost and volume can be better understood with the following example. Consider a *ring* broadcast of data of length γ units between P processes, i.e. p_0 sends a message of length γ to p_1 , which then relays it to p_2 and so on, until all the P processes have received the message. In this case, the time to finish the broadcast (T_{comm}) will be $(\alpha + \beta \gamma)(P-1)$, where α is the cost of initiating a message transmission, and β is the cost of sending a unit data. The communication cost W is the co-efficient of β in the expression for T_{comm} , i.e. $W = (P-1)\gamma^1$. On the other hand, in this example V^{avg} will be $\gamma(P-1)/P$ and $V^{max} = \gamma$.

Informally, the communication cost W correlates to the time to completion when an application is communication-bound. The average per-process communication volume V^{avg} is a measure of energy spent in the communication and network load due to the computation; and V^{max} in an indicator of communication imbalance and possible network contention. In a dynamic asynchronous computation such as SPTRs, its difficult to precisely measure W,



Figure 6: Communication pattern in dense LSOLVE in 2D grid

whereas V^{avg} and V^{max} can be measured readily, which is helpful in validating the analytical models that we develop in this section. Further, if a computation is entirely communication bound, then the following holds:

$$V^{avg} \leq V^{max} \leq W.$$

Thus, one can estimate a lower bound on W by using V^{max} . Hence V^{avg} and V^{max} provide an important insight into communication characteristics of any application.

4.1 Dense Triangular Solve on 2D Process Grid

Consider a dense lower triangular system Ly = b distributed on a square 2D process grid of dimension $\sqrt{P} \times \sqrt{P}$ as shown in the Fig. 6. For sake of simplicity, we assume that blocking parameter for 2D block cyclic data distribution is one and number of right hand side is one i.e. $b \in \mathbb{R}^n$.

4.1.1 Communication Cost W. The critical path for the L solve is shown in Fig. 6. In the k-step of dense L solve, process P_{kk} computes the y_k and broadcast it across the process column $P_c(k)$. The process $P_{k+1,k}$ computes $b_{k+1} = l_{k+1,k}y_k$ and sends it to the process $P_{k+1,k+1}$, which then computes y_{k+1} . Thus the total number of messages sent in the critical path of L-solve is 2(n - 1), and each message has length γ . So in the case of dense L solve total communication cost in the critical path is given by:

$$W_{Dense}(n,P) = O(n).$$
⁽²⁾

From Eq. (2), the communication cost in the dense *L*-solve in 2D process grid does not scale with the number of processors.

4.1.2 Communication Volume V. In the dense L solve, each process only sends and receives $O\left(\frac{n}{\sqrt{P}}\right)$ words. So the per-process communication volume, in this case, is given by:

$$V_{Dense}(n,P) = V_{Dense}^{avg}(n,P) = V_{Dense}^{max}(n,P) = O\left(\frac{n}{\sqrt{P}}\right).$$
 (3)

4.2 Planar Sparse Matrices

4.2.1 2D Sparse Triangular Solve. In the case of planar sparse matrices, the top level separator is a dense matrix of dimensions $O(\sqrt{n})$. So the cost solving the top separator will be $W_{Dense}(\sqrt{n}) =$

 $^{^1 \}rm We$ use #words as the unit for communication cost instead of time. This choice also facilitates direct comparison of communication cost and volume

 $O\left(\sqrt{n}\right)$. In the first level, we have two separators of dimension $O\left(\sqrt{n/2}\right)$. Since solving the two separators in this level is independent, and is done in parallel, therefore communication costs will be $W_{Dense}(\sqrt{n/2}) = O\left(\sqrt{n/2}\right)$. The 2D triangular solve can exploit the parallelism of degree up to \sqrt{P} . So for the triangular solve of any level-*i* such that $2^i \leq \sqrt{P}$, the communication cost will be $W_{Dense}(\sqrt{n/2^i}) = O\left(\sqrt{n/2^i}\right)$. Let lvl_0 be the first level where $2^{lvl_0} > \sqrt{P}$, i.e.,

$$lvl_0 = \min\left\{i \mid 2^i > \sqrt{P}, \ i \in \mathbb{Z}\right\} = \left\lceil \log_2 \sqrt{P} \right\rceil.$$
 (4)

So $lvl_0 \approx 1/2 \log P$. We can write the total communication cost of triangular solve from level-0 to level- $(lvl_0 - 1)$ as:

$$W_{l < l v l_0}(n, P) = \sum_{i=0}^{l v l_0 - 1} \sqrt{\frac{n}{2^i}} = O\left(\sqrt{n}\right)$$
(5)

For levels > lvl_0 , the 2D algorithm can exploit the \sqrt{P} parallelism. The total number of variables in levels > lvl_0 is $n - \sqrt{n}P^{1/4} = O(n)$. Hence the total communication cost in solving levels> lvl_0 is

$$W_{l \ge l \upsilon l_0}(n, P) = \frac{n - \sqrt{n}P^{1/4}}{\sqrt{P}} = O\left(\frac{n}{\sqrt{P}}\right).$$
(6)

From Eqs. (5) and (6), the total communication cost for the 2D algorithm for the planar problems is given by:

$$W_{2D}(n,P) = O\left(\frac{n}{\sqrt{P}} + \sqrt{n}\right). \tag{7}$$

Communication Volume. To calculate the communication volume of the 2D algorithm, the sparse triangular system can be considered as a sequence of dense triangular systems of supernodes of dimension n_i so that $\sum_i n_i = n$. Since in the case of dense triangular solve in 2D process grid $V^{avg} = V^{max}$ (from Eq. (3)), it will be the same in this case as well. So the communication volume can be written as follows:

$$V_{2D}(n,P) = \sum_{i} V_{Dense}(n_i,P) = \frac{\sum_{i} n_i}{\sqrt{P}} = O\left(\frac{n}{\sqrt{P}}\right).$$
(8)

4.2.2 3D Sparse Triangular Solve. For the 3D algorithm, we have $P = P_z P_{xy}$, where P_z is the number of 2D grids each with P_{xy} processes. The 3D algorithm uses P_z is a power of two, $P_z = 2^{l_z}$. In our analysis, we assume that the 2D grid is a square grid of dimension $\sqrt{P_{xy}} \times \sqrt{P_{xy}}$.

We consider the communication costs of any process in grid-0, since it lies in the critical path of the triangular solve. The leaf subtree in grid-0 has dimension $\approx n/P_z$. The leaf-subtree is solved by the 2D algorithm on a process grid of size P_{xy} . From Eq. (19), the communication costs of solving the leaf-subtree is:

$$W_{3D-leaf} = W_{2D}\left(\frac{n}{P_z}, P_{xy}\right) = O\left(\frac{n}{P_z\sqrt{P_{xy}}} + \sqrt{\frac{n}{P_z}}\right)$$
(9)

$$= O\left(\frac{n}{\sqrt{P_z P}} + \sqrt{\frac{n}{P_z}}\right). \quad (10)$$

In each level-*i*, from 0 to $l_z - 1$, the grid-0 solves a dense triangular system of size $\sqrt{n/2^i}$, which has a communication cost of $W_{Dense}(\sqrt{n/2^i}, P_{xy}) = \sqrt{n/2^i}$. Thus the total communication cost in solving from level-0 to $l_z - 1$ is given by:

$$W_{3D-Anc}(n,P) = \sum_{i=0}^{l_z-1} \sqrt{\frac{n}{2^i}} = O\left(\sqrt{n}\right)$$
(11)

Lastly, before solving any level-*i* from 0 to $l_z - 1$, grid-0 reduces the contribution from the other grids. In the *i*-th level, it receives vector of size $\sqrt{n/2^i}$. However, only the diagonal processes participate in this step. Hence the per-process communication cost for the reduction step in the *i*-th level is $\sqrt{\frac{n}{P_{xy}2^i}} = \sqrt{\frac{nP_z}{P2^i}}$. So the total communication cost in the reduction step from all the level is:

$$W^{z}(n, P, P_{z}) = \sum_{i=0}^{l_{z}-1} \sqrt{\frac{n}{P_{xy}2^{i}}} = O\left(\sqrt{\frac{nP_{z}}{P}}\right).$$
 (12)

Combining Eqs. (10) to (12), we obtain the following expression for the communication cost of the 3D algorithm for planar matrices:

$$W_{3D}(n, P, P_z) = O\left(\frac{n}{\sqrt{P_z P}} + \sqrt{\frac{n}{P_z}} + \sqrt{n} + \sqrt{\frac{nP_z}{P}}\right).$$
 (13)

Since $\sqrt{n} > \sqrt{\frac{n}{P_z}}$ and $\sqrt{n} > \sqrt{\frac{nP_z}{P}}$, hence we can simplify Eq. (13) to get the following expression:

$$W_{3D}(n, P, P_z) = O\left(\frac{n}{\sqrt{P_z P}} + \sqrt{n}\right)$$
(14)

Communication Volume. To get the average communication cost V^{avg} , it is sufficient to assume that each grid is solving a triangular solve of dimension n/P_z by using the 2D algorithm. Hence,

$$V_{3D}^{avg}(n,P) = V_{2D}^{avg}(\frac{n}{P_z},P_{xy}) = O\left(\frac{n}{\sqrt{P_z P}}\right).$$
 (15)

To calculate maximum per-process communication volume V^{max} , we consider the communication of any process in grid-0 since it participates in the all the level of triangular solve. The communication volume for any process in grid-0 has two components a) leaf-subtree solve which amount to $O\left(\frac{n}{\sqrt{P_z P}}\right)$; and b) ancestorsubtree solve, which has the same asymptotic complexity as solving top-level separator of dimension \sqrt{n} in 2D grid of size P_{xy} , i.e. $V_{Dense}(\sqrt{n}, P_{xy}) = \frac{\sqrt{n}}{\sqrt{P_{xy}}} = O\left(\frac{\sqrt{nP_z}}{\sqrt{P}}\right)$. Thus, we can write the maximum per-process communication of the 3D algorithm as:

$$V_{3D}^{max}(n, P, P_z) = O\left(\frac{n}{\sqrt{P_z P}} + \frac{\sqrt{nP_z}}{\sqrt{P}}\right)$$
(16)

To minimize $V_{3D}^{max}(n, P)$, we should have $P_z = n^{1/2}$, in which case $V_{3D}^{max}(n, P) = O\left(\frac{n^{3/4}}{\sqrt{P}}\right)$. Hence optimal $V_{3D}^{max}(n, P)$ is smaller by a factor of $n^{1/4}$ to $V_{2D}^{max}(n, P)$.

4.3 Non-planar Sparse Matrices

In the case of non-planar sparse matrices, the top level separator has dimension $n^{2/3}$, and nodes in the *i*-th level have dimension $(n/2^i)^{2/3}$.

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4.3.1 2D Sparse Triangular Solve. Similar to planar case, to calculate the communication costs of the 2D algorithm, we calculate $W_{l < l v l_0}(n, P)$ and $W_{l \ge l v l_0}(n, P)$, where $lv l_0$ is defined by Eq. (4). The corresponding equation to Eq. (5) for non-planar case can be written as:

$$W_{l < l v l_0}(n, P) = \sum_{i=0}^{l v l_0 - 1} \left(\frac{n}{2^i}\right)^{2/3} = O\left(n^{2/3}\right), \tag{17}$$

and equation corresponding to Eq. (6) is :

$$W_{l \ge l \upsilon l_0}(n, P) = \frac{n - n^{2/3} P^{1/4}}{\sqrt{P}} = O\left(\frac{n}{\sqrt{P}}\right).$$
(18)

So the total communication cost is given by:

$$W_{2D}(n,P) = O\left(\frac{n}{\sqrt{P}} + n^{2/3}\right)$$
 (19)

Communication Volume. Eq. (8) also holds for non-planar input problems.

4.3.2 3D Sparse Triangular Solve. Similar to planar case, we calculate $W_{3D-leaf}$, W_{3D-Anc} and W^z for non-planar problems as follows:

$$W_{3D-leaf} = W_{2D}\left(\frac{n}{P_z}, P_{xy}\right) = O\left(\frac{n}{\sqrt{P_z P}} + \sqrt{\frac{n}{P_z}}\right)$$
(20)

$$W_{3D-Anc}(n,P) = \sum_{i=0}^{l_z-1} \left(\frac{n}{2^i}\right)^{2/3} = O\left(n^{2/3}\right)$$
(21)

$$W^{z}(n, P, P_{z}) = \sum_{i=0}^{l_{z}-1} \left(\frac{n}{P_{xy}2^{i}}\right)^{2/3} = O\left(\left(\frac{nP_{z}}{P}\right)^{2/3}\right)$$
(22)
(23)

Combining Eqs. (20) to (22), we get the following expression for communication cost:

$$W_{3D}(n, P, P_z) = O\left(\frac{n}{\sqrt{P_z P}} + n^{2/3}\right)$$
 (24)

Communication Volume. The expression for V_{3D}^{avg} for planar input problem Eq. (15) also hold for non planar problems. Using a similar argument as for the case of planar problems, we arrive at following expression for V_{3D}^{max} for non-planar problems

$$V_{3D}^{max}(n, P, P_z) = O\left(\frac{n}{\sqrt{P_z P}} + n^{2/3}\frac{\sqrt{P_z}}{\sqrt{P}}\right)$$
(25)

To minimize communication volume, we should have $P_z = n^{1/3}$, in which case $V_{3D}^{max}(n, P) = O\left(\frac{n^{5/6}}{\sqrt{P}}\right)$. Hence optimal $V_{3D}^{max}(n, P)$ is smaller by a factor of $n^{1/6}$ to $V_{2D}^{max}(n, P)$.

In Table 2, we summarize the asymptotic communication cost and volume for SPTRS2D and SPTRS3D on planar and non-planar input problems. In Section 5.4, we present some empirical result on average and maximum per-process communication volume.

5 RESULTS

In this section, we present results from a series of numerical experiment to understand the scalability of 3D sparse triangular solver algorithm.

Table 3: Test sparse matrices used in experiments

Name	Application	n	nnz n
atmosmodd	CFD	1.3e6	6.9
boneS10	Model reduction	9.1e5	44.7
CurlCurl_4	Model Reduction	2.4e+6	10.9
dielFilterV3real	FEM/EM	1.1e+6	81.0
ldoor	Structural	9.5e+5	44.6
nlpkkt80	KKT matrices	1.1e+6	26.5
Ecology1	Ecology/Circuit	1.0e+6	5.0
S2D9pt3072	PDE	9.4e+6	9.0
Serena	Structural	1.4e+6	46.1
torso3	PDE	2.6e5	17.1

5.1 Experimental Set-up

5.1.1 Test Bed. We ran our experiments on a Cray XC30 machine "Edison" cluster at NERSC.² Each node of the Edison contains dual-socket 12-core Intel Ivy Bridge processors. We chose the SU-PERLU_DIST's default parameters for running experiments, which is tuned for factorization phase. We used 4 OpenMP threads per MPI process with hyperthreading disabled. We compiled our code with Intel C compiler version 18.0.0 and linked with Intel MKL version 2017.2.174 for BLAS operations.

5.1.2 Test Matrices. We used a mix of planar and non-planar test matrices coming from different real world applications to evaluate the performance of 3D sparse triangular solver. The test matrices are listed in Table 3. The planar matrices come from the discretization of two-dimensional PDE s2D9pt2048) and circuit analysis (Ecology1). Five of the six non-planar matrices are from the discretization of 3D PDEs and one, matrix nlpkkt80, comes from non-linear optimization. The solve time for 16 right hand sides ranges from .5-10 seconds on 16 nodes when using the baseline 2D SUPERLU_DIST.

5.2 Results on 16 nodes

On 16 nodes of the Edison cluster, the 3D sparse triangular solve configurations achieve $1.3-4.3 \times$ and $0.9-2.9 \times$ speedup with respect to 2D configuration for planar and non-planar matrices, respectively. The results appear in Fig. 7, which shows the factorization time normalized by the baseline 2D SUPERLU_DIST for each matrix and process configuration. Columns correspond to different 3D process configurations. The leftmost column, $P_z = 1$, is the 2D algorithm; subsequent columns correspond to P_z values of 2, 4, 8, and 16. The factorization time is divided into two components, T_{comp} and T_{comm} . The T_{comp} is the time spent in local computation on the critical path of the combined *L* and *U* solve, and T_{comm} is the non-overlapped communication and synchronization time.

5.3 Strong Scaling

Finally, we analyze the performance of 3D sparse triangular solver for different $P_{xy} \times P_z$ combinations for different number of right hand sides. For this experiment, we choose one planar matrix

²http://www.nersc.gov/users/computational-systems/edison



Figure 7: The Triangular Solve performance for 16 right hand sides for various $P_x \times P_y \times P_z$ grids on 16 nodes (384 CPU cores) of the Edison system at NERSC. For each matrix, each column represents a different value of $P_z = \{1, 2, 4, 8, 16\}$ from left to right. Thus, the leftmost column is the 2D algorithm, and when moving right, the 2D grids become smaller as P_z increases. For each data set, the time shown is normalized with respect to 2D SUPERLU_DIST on 16 nodes. T_{comp} represents the time spent in the local computation on the critical path, whereas T_{comm} is the non-overlapped time spent in communication and synchronization.

s2D9pt2048 and a non-planar matrix nlpkkt80. Let γ denotes the number of right hand sides.

$\gamma = #$ Right hand sides.

We choose three different number of right hand sides $\gamma \in \{1, 16, 64\}$ for this experiment.

Strong scaling for s2D9pt2048. We show the results for s2D9pt2048 on Fig. 8. When $\gamma = 1$, the best case 3D configuration is 4.7× faster than best case 2D process configuration. When $\gamma = 1$, each message sent is short, thus the performance of across different configuration is limited by the latency costs than the bandwidth cost. For the 2D process configurations, the performance does not scale well with increasing grid size. This reflects that despite enough parallelism post-ordering, block-cyclic data distribution on non-square grids may not distribute the load evenly. Therefore, the solve-phase remains predominantly sequential. Since 3D configurations do not suffer from these limitations, so solve-phase shows some scalability with increasing P_z .

For $\gamma = 16$, the best case 3D configuration is 7× faster than best case 2D process configuration. In this case, 2D process configurations, the performance is limited by data transfer costs and scales as $O\left(1/\sqrt{P}\right)$. Again in this case, for a small value of P_z performance scales linearly and after certain P_z for a given 2D grid size, adding more 2D grids do not result in any further performance gains.

The case $\gamma = 64$ is similar to the case $\gamma = 16$. In this case, the 3D configuration is again approximately 7× than the best case 2D configuration. In this case, we can exploit efficient BLAS-3 calls effectively for local computation. Moreover, in this case, the fraction of computation is significantly more than either data transfer or latency cost. Hence, we achieve higher performance in this case for any process configuration.

Strong scaling for nlpkkt80. We show the strong scaling results for nlpkkt80 on Fig. 9 for $\gamma = 1$, 16& 64.

When $\gamma = 1$, the 3D configuration achieves a best case speed up of 1.89× over 2D configurations. Similar to the case of s2D9pt2048 when $\gamma = 1$ performance of nlpkkt80 is limited by latency costs. However, since nlpkkt80 is a non-planar matrix, the latency costs increase more quickly compared to the planar case. For $\gamma = 16$ and

 $\gamma = 64$, the best case 3D configuration achieves a best case speed-up of 2.3× and 2.6× respectively.

In both cases, $\gamma = 16$ and $\gamma = 64$, we were able to scale to 24K cores of Edison, with continued improvement in performance.

5.4 Communication Volume

In Figs. 10 and 11, we show average and maximum per-process communication volume for s2d9pt2048 and nlpkkt80 on 96 and 384 MPI processes for $P_z \in \{1, 2, 4, 8, 16\}$ and $\gamma = 16$. The communication is divided into communication along *xy*-plane (shown in blue) and communication along *z* dimension (shown in red).

For both the matrices, the average per-process communication volume *V* (Figs. 10a and 11a) reduces as $\frac{1}{\sqrt{P_z}}$ for different P_z and constant total number of processes *P*. Similarly, *V* decreases as $\frac{1}{\sqrt{P}}$ with increasing *P* and constant P_z . Thus, we see a reduction of roughly 2× in average per-process communication volume when we go from *P* = 96 to *P* = 384. This agrees with our models for communication volume described in Eqs. (16) and (25). In all the cases, communication, volume along *z*-dimension is a tiny fraction of total communication.

The maximum per-process communication volume for the 2D algorithm (Figs. 10b and 11b) is 2.3× the average communication volume, indicating some communication imbalance. The 3D configurations, besides reducing average per-process communication, also attenuate the communication imbalance, e.g. at 96 processors $P_z = 2$ maximum per-process communication is 1.4 and 1.42× the average per-process communication for s2d9pt2048, and nlpkkt80; whereas for the 2D algorithm ($P_z = 1$), the ratio of maximum versus average per-process communication is 2.2 and 2.3× for s2d9pt2048, and nlpkkt80, respectively.

6 RELATED WORK

Complimentary to our approach of reducing communication by employing 3D process grid, researchers have looked into selective inversion [11, 19, 22] re-ordering to adapt to structure [23], improving performance of collective operations [17]. Multifrontal methods with the so-called subtree-to-subcube mapping [7] also elimination tree parallelism to improve locality and reduce communication. One notable example of such algorithm is described by Gupta in



Figure 8: The triangular solve performance (in Gigaflop/s) for different number of right hand sides (γ) for different P_{xy} × P_z for planar matrix s2D9pt2048.



Figure 9: The triangular solve performance (in Gigaflop/s) for different number of right hand sides (γ) for different $P_{xy} \times P_z$ for non-planar matrix nlpktt80.



Figure 10: Per-processs Communication Volume for s2d9pt2048: Fig. 10a shows the average per-process communication volume for 96(left) and 384(right) MPI processes for different P_z ; Fig. 10b shows the maximum perprocess communication volume for 96(left) and 384(right) MPI processes for different P_z .

[9] for Cholesky factorization, and they provide an efficient triangular solver for such mapping [14]. Interested readers can find a more comprehensive discussion on differences in right-looking and multifrontal methods elsewhere [10, 20].

For dense triangular solve, communication-avoiding algorithm that uses 3D process grid have been proposed and analyzed in [13, 24].



(a) Average per-process communi(b) Maximum per-process commucation nication

Figure 11: Per-processs Communication Volume for nlpkkt80: Fig. 11a shows the average per-process communication volume for 96(left) and 384(right) MPI processes for different P_z ; Fig. 11b shows the maximum perprocess communication volume for 96(left) and 384(right) MPI processes for different P_z .

In [4, 12], authors have proposed communication avoiding method for constructing Krylov Subspace for iterative solver. In theory, such techniques can be also applied for iterative solvers that uses triangular preconditioners. For stationary iterations, researchers have explored asynchronous iterations to reduce synchronization costs [2, 3, 5]

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Beyond the case of sparse linear solvers, machine learning algorithms on large and sparse data has renewed interest for communication efficient algorithm for other sparse matrix operations. This has lead to communication avoiding and efficient algorithms for sparse times dense matrix multiplication[16], sparse-sparse matrix multiplication algorithm has been discussed at [1, 8, 25].

7 CONCLUSION

This paper extends the use of a 3D data structure for sparse LU factorization, described previously [21], to sparse triangular solve. Our analysis shows that the resulting SpTRs also becomes communicationavoiding.

Interestingly, a better SPTRs like this one can lead to a better overall direct solver. At present, SUPERLU_DIST3D factors the matrix using a 3D process grid of size $P_x \times P_y \times P_z$ and then gathers the LU factors into a 2D of dimension $P_x \times P_y$ to perform its SPTRs. By contrast, our new 3D triangular solve eliminates the need for gathering the L and U factors, enabling the use of all $P_x \times P_y \times P_z$ processors. Besides mitigating such an inefficiency, the 3D SPTRs is an algorithmic advancement over the the 2D algorithm that improves the asymptotic communication. Thus, while this paper focuses on SPTRs, complete integration into the complete direct solver is an important next step.

Despite these improvements, the dense triangular solve in ancestor subtrees, is not fully parallel, leading to $O(\sqrt{n})$ and $O(n^{2/3})$ terms in the communication costs for SPTRS3D on 2D and 3D problems. That does not scale with the number of processors. Since the dimension of the ancestor subtrees is smaller than the dimension of the problem by an order of magnitude, a different strategy may be viable. In particular, it may be practical to compute the inverses of dense *L* and *U* factors of ancestor-subtrees and perform matrixvector multiplication with L^{-1} and U^{-1} instead of performing a triangular solve. These inverses can be computed during the process of factorization without any additional communication-overhead, and will increase computation and memory at most by a factor of two. We plan to investigate the feasibility of this approach in the future.

Prior to this work, much of the work in communication avoiding sparse and dense linear algebra was limited to BLAS Level-3 style matrix-matrix type operations. This work presents one of the first cases known to us of using communication avoiding algorithm and 3D process grid for sparse matrix-vector style operation, or BLAS Level-2 operations. However, sparse triangular matrices in the direct solver have significantly more non-zeros per-row (e.g. O (logn), $O(n^{1/3})$, for 2D and 3D problems respectively) than general sparse matrices, which typically have O(1) non-zeros per row. Nevertheless, in principle, the idea of using nested-dissection-type 3D data distributions can be extended to other sparse BLAS Level-2 and Level-3 operations, such as distributed sparse matrix time dense vector/matrix multiplication, sparse-sparse matrix multiplication, sparse QR factorization, and graph algorithms such as breadth-first search and all pair shortest path. Finding the efficacy of nesteddissection driven 3D data distribution approach for other sparse problems is another avenue for future investigation.

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